



(2.00 mm) .0787" PITCH • TIGER EYE™ SOCKET

SMM



NO. PINS PER ROW

PLATING OPTION

ROW OPTION

OTHER OPTIONS

02 thru 40

= Gold flash on contact, Matte Tin on tail

= 10 µ" (0.25 µm) Gold on contact, Matte Tin on tail

-S = 30 μ" (0.76 μm) Gold on contact, Matte Tin on tail

-S = Single Row

-D = Double Row

-"XX" = Polarized Position

-K = (5.50 mm) .217" DIA Polyimide Film Pick & Place Pad (2 positions minimum, –02 thru –05 requires –TR)

= Plastic Pick & Place Pad (-02 thru -05 requires -TR)

= Tape & Reel Packaging (27 positions maximum)

-FR = Full Reel Tape & Reel (must order maximum

quantity per reel; contact Samtec for quantity breaks) (27 positions maximum)

SMM

Board Mates:

TMM, TMMH, MTMM, MMT, LTMM, TW, PTT, ZLTMM

Cable Mates:

TCMD

SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer Contact Material: Plating: Sn or Au over 50 μ" (1.27 μm) Ni Current (TMM/SMM): 3.2 A per pin (2 pins powered) Voltage Rating: 350 VAC Operating Temp Range: -55 °C to +125 °C Insertion Depth: (3.05 mm) .120" to (3.25 mm) .128" Max Cycles:

PROCESSING

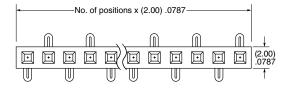
100 with 10 μ" (0.25 μm) Au

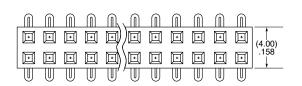
Lead-Free Solderable:

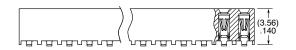
SMT Lead Coplanarity: (0.15 mm) .006" max* *(.004" stencil solution may be available; contact ipg@samtec.com)

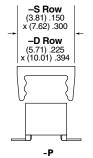
ALSO AVAILABLE MOQ Required

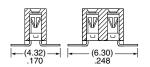
Locking Clip (Manual placement required) Other platings











Note:

Some lengths, styles and options are non-standard, non-returnable.

View complete specifications at: samtec.com?SMM